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3 **3GPP2 CORRESPONDENCE**  
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12 June 30, 2006

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14 Mr. Jari Arkko  
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14 Mr. Mark Townsley  
15 Internet Area Director  
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20 **Subject: Generic EAP Encapsulation**  
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22 Dear Thomas, Jari, and Mark,  
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25 3GPP2 is planning to use Generic EAP Encapsulation (GEE, draft-barany-eap-gee) to allow  
26 parallel EAP transactions, and we have added it in our IETF dependency list.  
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28 Therefore, we request your support for progressing this draft.  
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31 Many thanks for your consideration.  
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35 Regards,  
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38 AC Mahendran  
39 3GPP2 Liaison to IETF  
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43 cc: V. Bosserman, 3GPP2 Secretariat, [vbosserman@tiaonline.org](mailto:vbosserman@tiaonline.org)  
44 Y.K. Kim, Chair, 3GPP2 SC, [ykkim@lgtel.co.kr](mailto:ykkim@lgtel.co.kr)  
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